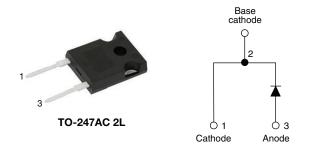


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Fast Soft Recovery Rectifier Diode, 40 A



PRIMARY CHARACTERISTICS					
I _{F(AV)}	40 A				
V_{R}	1000 V, 1200 V				
V _F at I _F	1.4 V				
I _{FSM}	475 A				
t _{rr}	95 ns				
T _J max.	150 °C				
Package	TO-247AC 2L				
Circuit configuration	Single				
Snap factor	0.5				

FEATURES

- Glass passivated pellet chip junction
- 150 °C max. operating junction temperature
- Low forward voltage drop and short reverse recovery time
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

These devices are intended for use in output rectification and freewheeling in inverters, choppers and converters as well as in input rectification where severe restrictions on conducted EMI should be met.

DESCRIPTION

The VS-40EPF12-M3, fast soft recovery rectifier series has been optimized for combined short reverse recovery time and low forward voltage drop.

The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES	UNITS			
V_{RRM}		1000/1200	V			
I _{F(AV)}	Sinusoidal waveform	40	Δ.			
I _{FSM}		475	A			
t _{rr}	1 A, 100 A/μs	95	ns			
V _F	20 A, T _J = 25 °C	1.25	V			
T _J		-40 to +150	°C			

VOLTAGE RATINGS						
PART NUMBER	V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I _{RRM} AT 150 °C mA			
VS-40EPF10-M3	1000	1100	10			
VS-40EPF12-M3	1200	1300	10			

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum average forward current	I _{F(AV)}	T _C = 105 °C, 180° conduction half sine wave	40			
Maximum peak one cycle	I _{FSM}	10 ms sine pulse, rated V _{RRM} applied 400		Α		
non-repetitive surge current		10 ms sine pulse, no voltage reapplied	475			
Maximum I ² t for fusing	I ² t	10 ms sine pulse, rated V _{RRM} applied	800	A ² s		
Maximum i-t for fusing	1-1	10 ms sine pulse, no voltage reapplied 1131		A-5		
Maximum I ² √t for fusing	l²√t	t = 0.1 ms to 10 ms, no voltage reapplied	11 310	A²√s		

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VS-40EPF1.-M3 Series

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ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CO	NDITIONS	VALUES	UNITS	
Maximum forward voltage drop	V_{FM}	40 A, T _J = 25 °C		1.4	V	
Forward slope resistance	r _t	T _{.1} = 150 °C		6.82	mΩ	
Threshold voltage	V _{F(TO)}	1J = 150 C		0.94	V	
Maximum rayaraa laakaga ayrrant	1	T _J = 25 °C	V _R = Rated V _{RRM}	0.1	mΛ	
Maximum reverse leakage current	IRM	T _J = 150 °C	VR = hateu VRRM	10	mA mA	

RECOVERY CHARACTERISTICS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	· †
Reverse recovery time	t _{rr}	In at 10 Anu	450	ns	I _{FM} t
Reverse recovery current	I _{rr}	I _F at 10 A _{pk} 25 Α/μs	6	Α	\
Reverse recovery charge	Q _{rr}	25 °C	1.8	μC	dir/Q _{rr}
Snap factor	S		0.5		I _{RM(REC)}

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction and storage temperature range		T _J , T _{Stg}		-40 to +150	°C	
Maximum thermal resista junction to case	nce,	R _{thJC}	DC operation	0.6		
Maximum thermal resistance, junction to ambient		R _{thJA}		40	°C/W	
Typical thermal resistance case to heatsink	Typical thermal resistance, case to heatsink		Mounting surface, smooth and greased	0.2		
Approximate weight				6	g	
Approximate weight				0.21	OZ.	
Marinting taxous	minimum			6 (5)	kgf ⋅ cm	
Mounting torque maximum				12 (10)	(lbf ⋅ in)	
			Case style TO-247AC 2L 40		F10	
Marking device			Case style TO-247AC modified		F12	

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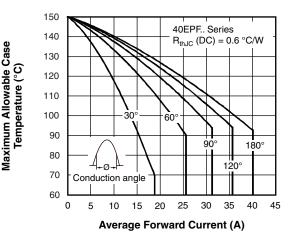


Fig. 1 - Current Rating Characteristics

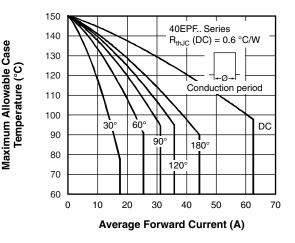


Fig. 2 - Current Rating Characteristics

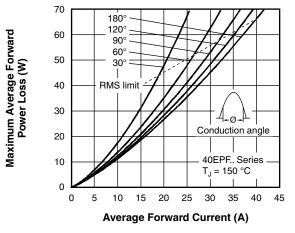


Fig. 3 - Forward Power Loss Characteristics

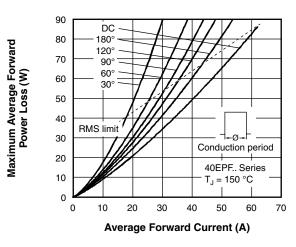


Fig. 4 - Forward Power Loss Characteristics

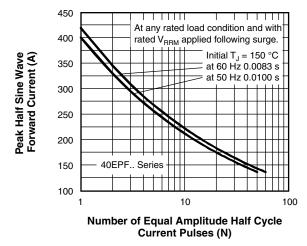


Fig. 5 - Maximum Non-Repetitive Surge Current

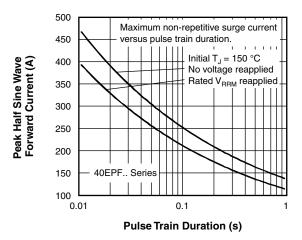


Fig. 6 - Maximum Non-Repetitive Surge Current

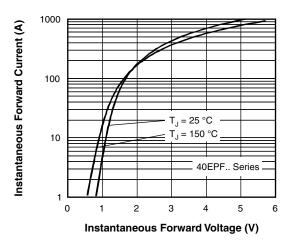


Fig. 7 - Forward Voltage Drop Characteristics

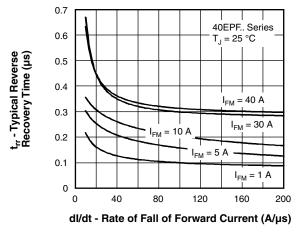


Fig. 8 - Recovery Time Characteristics, T_J = 25 °C

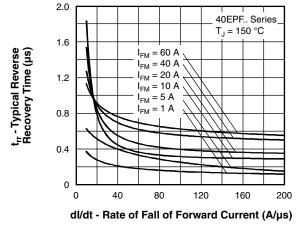


Fig. 9 - Recovery Time Characteristics, $T_J = 150 \, ^{\circ}\text{C}$

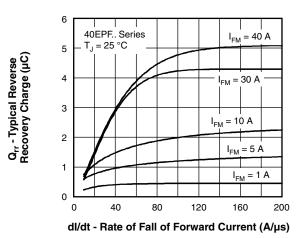


Fig. 10 - Recovery Charge Characteristics, T_J = 25 °C

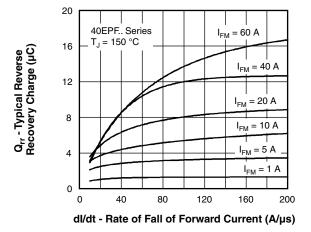
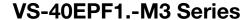


Fig. 11 - Recovery Charge Characteristics, T_J = 150 °C

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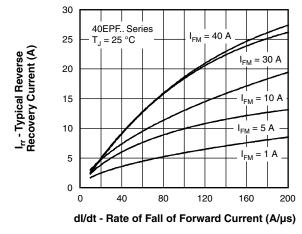


Fig. 12 - Recovery Current Characteristics, T_J = 25 °C

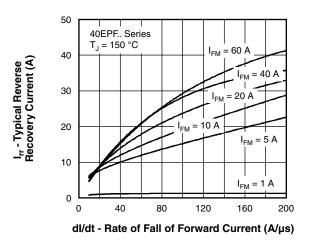


Fig. 13 - Recovery Current Characteristics, T_J = 150 °C

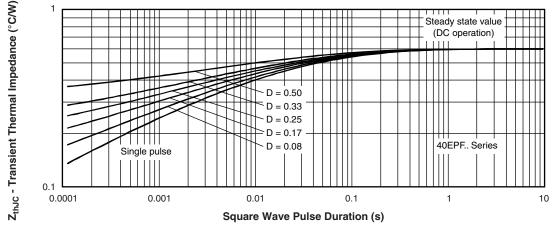
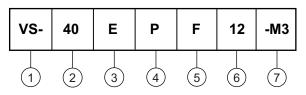


Fig. 14 - Thermal Impedance Z_{thJC} Characteristics



ORDERING INFORMATION TABLE

Device code



Vishay Semiconductors product

2 - Current rating (40 = 40 A)

3 - Circuit configuration:

E = single diode

4 - Package:

P = TO-247AC 2L

5 - Type of silicon:

F = fast recovery

6 - Voltage code x 100 = V_{RRM} 10 = 1000 V 12 = 1200 V

7 - Environmental digit:

-M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)					
PREFERRED P/N QUANTITY PER T/R MINIMUM ORDER QUANTITY PACKAGING DESCRIPTION					
VS-40EPF10-M3	25	500	Antistatic plastic tubes		
VS-40EPF12-M3	25	500	Antistatic plastic tubes		

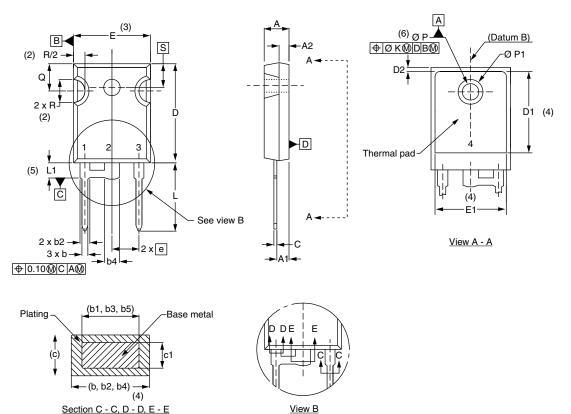
LINKS TO RELATED DOCUMENTS				
Dimensions	TO-247AC 2L	www.vishay.com/doc?96144		
Dimensions -	TO-247AC modified	www.vishay.com/doc?95541		
Part marking information -	TO-247AC 2L	www.vishay.com/doc?95648		
	TO-247AC modified	www.vishay.com/doc?95442		

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TO-247AC modified - 50 mils L/F

DIMENSIONS in millimeters and inches



	BALL LIBA	IETERS	INC	HES	
SYMBOL					NOTES
	MIN.	MAX.	MIN.	MAX.	
Α	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.17	1.37	0.046	0.054	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
С	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MILLIM	IETERS	INC	HES	NOTES
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
D2	0.51	1.35	0.020	0.053	
E	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
е	5.46	BSC	0.215	BSC	
ØK	0.2	254	0.0)10	
L	14.20	16.10	0.559	0.634	
L1	3.71	4.29	0.146	0.169	
ØΡ	3.56	3.66	0.14	0.144	
Ø P1	-	7.39	-	0.291	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51	BSC	0.217	BSC	

Notes

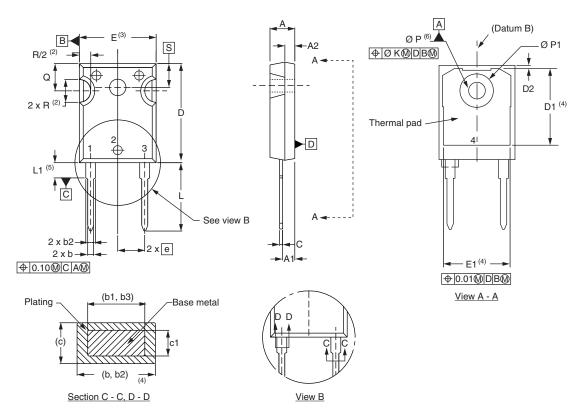
- (1) Dimensioning and tolerance per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension c and Q

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TO-247AC 2L

DIMENSIONS in millimeters and inches



SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STWIBOL	MIN.	MIN. MAX.		MAX.	NOTES
Α	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.17	1.37	0.046	0.054	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
С	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4
D2	0.51	1.35	0.020	0.053	

SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	NOTES
E	15.29	15.87	0.602	0.625	3
E1	13.46	=	0.53	-	
е	5.46 BSC		0.215 BSC		
ØK	0.254		0.010		
L	14.20	16.10	0.559	0.634	
L1	3.71	4.29	0.146	0.169	
ØΡ	3.56	3.66	0.14	0.144	
Ø P1	-	7.39	-	0.291	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51 BSC		0.217 BSC		
	•				

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension Q

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